

# MeiG Smart Technology Co., Ltd

A Global Leading Supplier of Cellular Modules and Solutions

**5G** 

The text '5G' is in a large, bold, red font. To its right is a red signal icon consisting of three curved lines of increasing size, representing a 5G signal.

To be the Pioneer

# About MEIG



**Global Market Layout**  
20+ carriers cooperation  
3000+ customers  
Global sales service

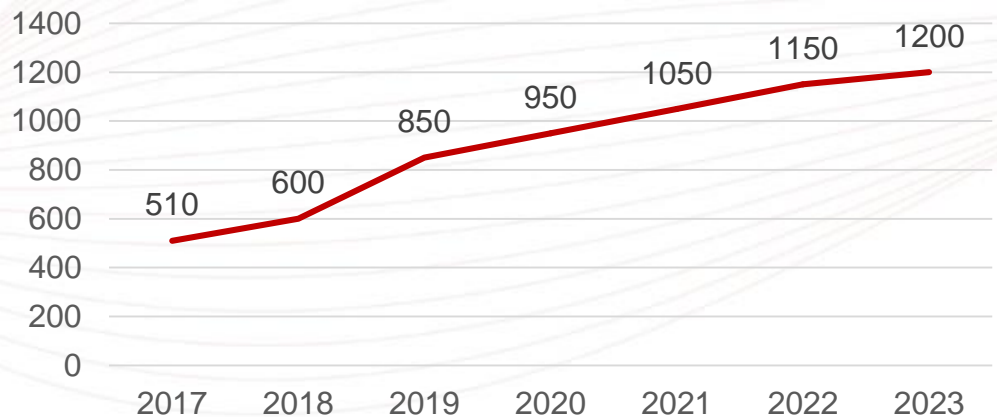
**Developing Momentum**  
50% IoT business growth  
30% Team growth rate  
20% R&D investment

**R&D Driven**  
800+R&D teams  
200+patents  
5G sub-6G&mmWave  
5G SoC solutions

**Delivery**  
3KK/month SMT  
1KK/month Assembly  
2 Domestic EMS Factories  
1 Overseas EMS Factory



## MeiG Team



- Listed on Shenzhen Stock Exchange (SZ: 002881)
- 2 R&D Center and foreign branch companies
- 5G IOT Module Mass Production
- Global Cooperation with Tier1 customers as AT&T, Inseego, TIM, Tracfone, Xiaomi, Telefonica, Orange
- Focus on FWA, IoT and Auto market

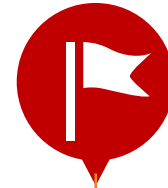
# History & Milestone



- Certified by ISO 9001 & ISO14001
- Signed LTE License with Qualcomm

- Huawei vehicle modules
- Xi'an Research Center founded
- Smart Module MP-SLM753, SLM755
- Shareholding reform & IPO formal application

- IoT R&D staff over 900
- Over 1000 customers
- SLM755L, SLM756, SLM757, SLM758 pass AT&T certification
- Cooperate with KDDI, Lime, T-Mobile, Tracfone, AT&T
- Pass IATF16949 certification in 2019
- Signed 5G License with Qualcomm



## ● Take Root 2009-2011

## ● Progress 2014-2015

## ● Move Forward 2018-2019

### 2007-2008

#### ● Start

- Foundation in Shenzhen
- Shanghai R&D center was founded



### 2012-2013

#### ● Develop

- National Hi-tech Enterprise
- Softbank & CMCC supplier for MiFi & Dongle
- LTE M2M Module MP-SLM730, SLM750



### 2016-2017

#### ● Leading

- Stocks listed on Shenzhen Stock Exchange-002881
- 100+ industry customers
- Cooperate with Continental, DoCoMo, Honeywell
- Smart Module MP-SLM755L, SLM756, SLM757, SLM758
- Automotive Module: MA800
- NB-IoT Module: SLM151



### 2020~2023...

#### ● Better Future

- 5G mmWave FWA products delivered to American operators
- 3000+ module customers
- 5G smart module applied in intelligent cockpit MP
- Successful Tenderer for China Unicom Cat1 & 5G projects
- MeiG Smart Manufacturing & Reliability Testing Center
- 5G Auto Smart Module MP in BYD



# Business Development Planning

Revenue \$312Million

Revenue \$340 Million

Revenue \$420 Million

IoT module



**M2M Module**

- 4G : 25%
- 5G : 9%

**Smart Module**

- 4G : 54%
- 5G : 11%

Accounts for 35%  
(Auto: 42%)



**M2M Module**

- 4G: 18%
- 5G: 17%

**Smart Module**

- 4G: 35%
- 5G: 30%

Accounts for 42%  
(Auto: 66%)



**M2M Module**

- 4G: 17%
- 5G: 23%

**Smart Module**

- 4G: 27%
- 5G: 30%

**Module with high computing power**

- 3%

Accounts for 43%  
(Auto: 70%)

FWA



**IDU & ODU**

- 4G: 40%
- 5G: 20%

**MIFI & Dongle**

- 4G: 29%
- 5G: 11%

Accounts for 35%



**IDU & ODU**

- 4G: 32%
- 5G: 28%

**MIFI & Dongle**

- 4G: 18%
- 5G: 22%

Accounts for 35%



**IDU & ODU**

- 4G: 24%
- 5G: 42%

**MIFI**

- 4G: 14%
- 5G: 20%

Accounts for 35%

Customized Service



**PCBA**

- 4G: 73%
- 5G: 27%

Accounts for 30%



**ODM**

- 4G: 25%
- 5G: 15%

**PCBA**

- 4G: 30%
- 5G: 30%

Accounts for 23%



**ODM**

- 5G: 24%
- 4G: 17%

**PCBA**

- 5G: 18%
- 4G: 43%

Accounts for 22%

## Business Goal in 5 Years:

- Core business: 30% YoY growth, reaching \$1.5 billion revenue in 2026.
- Overseas business: exceed 50%
- Auto business: reach 30%

**Advance with partners**

2021

2022

2023

2026



# R&D Capability



## R&D Team

- Over **800** R&D personnel
- **90%** have bachelor degree or above
- **59%** have 5+ years working experience
- Team growth rate reached **30%**  
Expected to attain 1,500 employees in 2023

## R&D Labs

- **>\$14M Investment**
- **5 x** Shielding Rooms
- **8000** square meters for testing labs
- Simulation **100+** network environment
- Simulation production line and test

## Reliability Labs

- Environment & ORT
- Component reliability
- Waterproof and dustproof
- Failure analysis
- Static Protection
- Environmental verification



## 5G Capability

- **5G Antenna Design & Test**
- **Thermal Simulation & Design**
- **5G NR Sub6 Physical & Application Layer Performance Test**

## 5G Test Instruments

- **KeySight** Sub6G & mmW Test Equipment
- **Anritsu** Sub6G & mmW Test Equipment



# Certification



The collage displays several key certifications and approvals:

- CE:** BACQ Directive 2014/53/EU EU Type Examination Certificate. Includes a CE mark and a gold award seal.
- FCC:** FCC RF Test Report from NVLAP, dated 04/11/2023.
- PTCRB:** Initial Certification Test Report from PTCRB, dated 04/11/2023.
- CTA:** China Telecom Administration (CTA) Certificate of Approval for Importation of Telecommunication Equipment, issued on 2023-09-21.
- JATE:** Design Approval Certificate (設計認証書) issued by JATE.
- IC:** Technical Acceptance Certificate (US0186) issued by SGS.
- AT&T:** Approval from AT&T Mobility.
- TMO:** Approval from T-Mobile.
- Verizon:** Approval from Verizon Wireless.



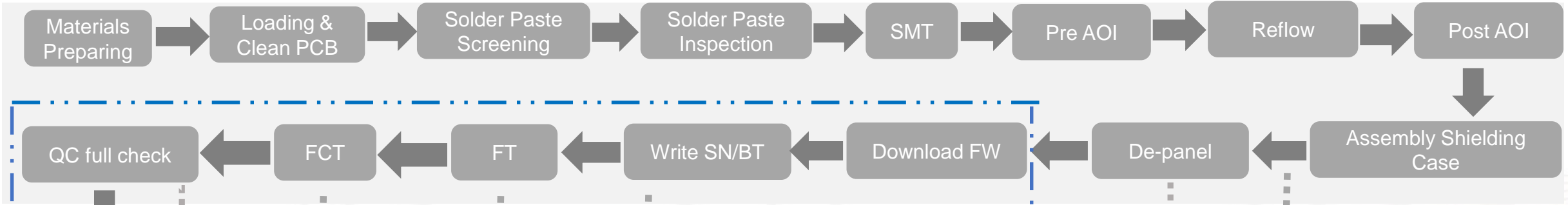
- More than 200 products have been delivered to 80% region of the world
- Rich experience in certification and carriers' technical approval tests of IoT products
- GCF/CE/FCC/PTCRB/CCC/CTA/SRRC/Jate/Telec/RCM/EAC/WEEE&RoHS;
- AT&T/Verizon/TMO/Trafone/VDF/Orange/KDDI/Docomo/Telefonica/Telcel/TIM/MTN;



# Quality Control



**IPQC Check FAI, Check the component Type, Polarity, etc.by BOM &Layout**



**IPQC Sample Inspection**

**Sample Inspection Quality with X-ray Machine**

**Check Appearance Quality with MES**



- MeiG self-developed MES system
- Highly matched product characteristics



- Systematic Interception



# Manufacturing

## Shuoge HZ China



### MeiG self-owned factory

Shuoge is an intelligent factory owned by MeiG, covering an area of 14,000 square meters. It is constructed for 5G automotive modules, 5G customization, standard modules, etc. The production line is highly automated and has industrial-leading equipment, which can guarantee a module capacity of 5KK/ month and complete unit assembly capacity of 1KK/ month.

## BYD SZ China



### Partnership with BYD

Founded in February 1995, BYD has set up more than 30 industrial parks around the world. As a leading global electronics manufacturing service enterprise, it produces products such as mobile phone, PAD, laptop, automotive electronics, etc. Its customers include Huawei, Lenovo, Telit, DJI, Amazon and other well-known enterprises at home and abroad.

## Meiko Vietnam



### Partnership with Meiko

Meiko is a well-known Japanese PCB manufacturing enterprise. In 2008, Vietnam Meiko started EMS manufacturing service business, operating car products, HDD and mobile phones. Its main customers are Stanley, Vinfast, Hitachi and other well-known enterprises.

## Meiko Japan



### Partnership with Meiko

Meiko Embedded established in 2001 under the NEC Group, which is an ODM development and manufacturing manufacturer that joined the Meiko Group in 2022. We are developing various applications such as in-vehicle products such as DMS, communication terminals, and printers.

**Capacity: SMT 3kk/ Month, Assembly 1kk/Month**

➤ 5G module 99.2% yield, Cat1 module 99.5% yield, 100% automation rate



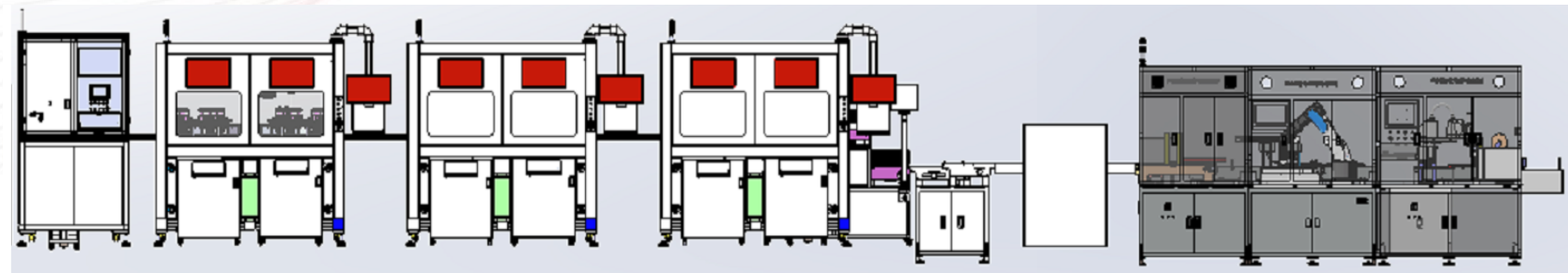
# Automated Manufacturing for Module

## SMT Whole Line Diagram



ERSA Selective Machine

## Automated Test Line (Standard Module & PCB Apply)




# MBB Chip Roadmap

- Launched
- Developing
- Planning

5G

4G



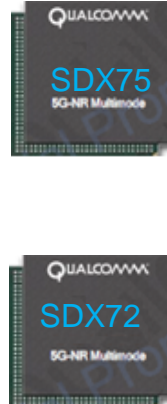
**SDX55**

- 3GPP Rel 15
- SA and NSA Sub-6
- NSA mmWave
- Sub-6GHz 5G FDD and TDD
- 4G: 20-layer DL/ 2CA UL



**SDX65/62**

- 3GPP Rel 16 Up to 10Gbps
- mmWave: 800MHz
- Sub6:300MHz,4CC CA
- 8RX and PC1.5 Support
- 4G: 20-layer DL/2CA UL
- Cost: High
- 3GPP Rel 16 Up to 4.4Gbps
- mmWave: 400MHz
- Sub6: 120MHz, 2CC CA
- PC1.5 Support
- 4G:16-layer DL/2CA UL
- Cost: Low



**SDX75/72**

- 3GPP Rel 17 modem
- Sub6G & mmWave SA/NSA




**9X50**

- 3GPP Rel 11
- LTE Cat 16 (DL)/Cat 13 (UL) multi-mode



**V510**

- 3GPP Rel 15
- NR NSA(EN-DC) and SA
- NR DL/ UL : 2Gbps/ 1Gbps




**SDX35**

- 3GPP Rel 17 Redcap modem
- sub6G SA



**9X07**

- Cortex-A7, up to 1.2 GHz
- 3GPP Rel 9 LTE Cat 4



**X12**

- 3GPP Rel 12
- LTE Cat 12 (DL)/Cat 13 (UL) multi-mode




**8520**

- 3GPP Rel 16
- Sub-6G/Sub-7GHz
- NR 100MHz+100MHz
- NRLLC
- LTE Cat19




**1826/1828**

- ARM Cortex-A7
- LTE Cat 7 multi-mode



**1803**

- ARM Cortex-A7
- LTE Cat 4 multi-mode



**83XX**

- 3GPP Rel 17 Redcap
- Linux&RTOS
- PCIe,ETH,USB
- -40°C~85°C



# M2M Module

5G  
LTE-A  
LTE  
Cat1  
NB/CatM

	<b>SRM815 M.2</b> <ul style="list-style-type: none"> <li>X55</li> <li>5G NR Sub6</li> <li>M.2</li> <li>56*43*3.65mm</li> </ul>	<b>SRM815-GL</b> <ul style="list-style-type: none"> <li>X55</li> <li>5G NR SA&amp;NSA</li> <li>LGA</li> <li>44*43*2.8mm</li> </ul>	<b>SRM825W</b> <ul style="list-style-type: none"> <li>X55</li> <li>5G NR Sub6 &amp; mmWave</li> <li>M.2</li> <li>30*52*3.6mm</li> </ul>	<b>2022Q2 SRM825WN</b> <ul style="list-style-type: none"> <li>X62</li> <li>5G NR Sub6 &amp; mmWave</li> <li>M.2</li> <li>30*52*2.3mm</li> </ul>	<b>2022Q3 SRM815N</b> <ul style="list-style-type: none"> <li>X62</li> <li>5G NR SA&amp;NSA</li> <li>LGA</li> <li>44*43*2.75mm</li> </ul>
<b>SRM815</b> <ul style="list-style-type: none"> <li>X55</li> <li>5G NR Sub6</li> <li>LGA</li> <li>44*41*2.8mm</li> </ul>	<b>SRM815 MiniPCIE</b> <ul style="list-style-type: none"> <li>X55</li> <li>5G NR Sub6</li> <li>Mini PCIe</li> <li>51*49*5.4mm</li> </ul>	<b>SRM825L</b> <ul style="list-style-type: none"> <li>Qualcomm 315</li> <li>5G NR SA</li> <li>M.2</li> <li>30*52*3.6mm</li> </ul>	<b>SRM811</b> <ul style="list-style-type: none"> <li>Unisoc V510</li> <li>5G NR SA&amp;NSA</li> <li>LGA</li> <li>44*41*2.8mm</li> </ul>	<b>2022Q2 SRM821</b> <ul style="list-style-type: none"> <li>Unisoc V510</li> <li>5G NR SA&amp;NSA</li> <li>M.2</li> <li>30*52*2.3mm</li> </ul>	<b>2022Q4 SRM827W</b> <ul style="list-style-type: none"> <li>X65</li> <li>5G NR Sub6 &amp; mmWave</li> <li>M.2</li> <li>30*52*2.3mm</li> </ul>
	<b>SLM820</b> <ul style="list-style-type: none"> <li>MDM9x50</li> <li>LTE Cat6/12/16</li> <li>M.2</li> <li>30*42*2.3mm</li> </ul>	<b>SLM828</b> <ul style="list-style-type: none"> <li>SDX12</li> <li>LTE Cat6</li> <li>Mini PCIE</li> <li>51*30*4.5mm</li> </ul>	<b>SLM828-G</b> <ul style="list-style-type: none"> <li>SDX12</li> <li>LTE Cat6/12</li> <li>LGA</li> <li>39.5*37*3mm</li> </ul>		<b>2022Q3 SLM828-M</b> <ul style="list-style-type: none"> <li>SDX12</li> <li>LTE Cat6/12</li> <li>M.2</li> <li>30*42*2.3mm</li> </ul>
<b>SLM750-VX</b> <ul style="list-style-type: none"> <li>MDM9X07</li> <li>LTE Cat4</li> <li>LCC</li> <li>32*29*2.8mm</li> </ul>	<b>MA800</b> <ul style="list-style-type: none"> <li>MDM9628</li> <li>LTE Cat4</li> <li>LGA</li> <li>37.5*33*3.0mm</li> </ul>	<b>SLM790</b> <ul style="list-style-type: none"> <li>Hisi V711</li> <li>LTE Cat4</li> <li>LCC</li> <li>29*32*2.8mm</li> </ul>		<b>2022Q2 SLM750-G</b> <ul style="list-style-type: none"> <li>MDM9X07</li> <li>LTE Cat4</li> <li>LCC</li> <li>32*29*2.8mm</li> </ul>	
<b>SLM730</b> <ul style="list-style-type: none"> <li>MDM9X07</li> <li>LTE Cat4</li> <li>Mini-PCle</li> <li>51*30*4.5mm</li> </ul>	<b>SLM750-ZX</b> <ul style="list-style-type: none"> <li>MDM9X07</li> <li>LTE Cat1</li> <li>LCC</li> <li>32*29*2.8mm</li> </ul>	<b>SLM750-ZX Mini PCIE</b> <ul style="list-style-type: none"> <li>MDM9X07</li> <li>LTE Cat1/CAT4</li> <li>PCIE</li> <li>51.0*30.0*4.8mm</li> </ul>		<b>2022Q2 SLM770U</b> <ul style="list-style-type: none"> <li>Unisoc 8310</li> <li>LTE Cat4</li> <li>LCC+LGA</li> <li>32*29mm</li> </ul>	<b>2022Q2 SLM770A</b> <ul style="list-style-type: none"> <li>ASR1803</li> <li>LTE Cat4</li> <li>LCC+LGA</li> <li>32*29mm</li> </ul>
<b>SLM320</b> <ul style="list-style-type: none"> <li>8910DM</li> <li>LTE Cat1</li> <li>LCC+LGA</li> <li>32*29*2.6mm</li> </ul>	<b>SLM330</b> <ul style="list-style-type: none"> <li>8910DM</li> <li>LTE Cat1</li> <li>LCC+LGA</li> <li>29*25*2.4mm</li> </ul>	<b>SLM328</b> <ul style="list-style-type: none"> <li>8910DM</li> <li>LTE Cat1</li> <li>LCC+LGA</li> <li>19.6*21.8mm</li> </ul>	<b>SLM322</b> <ul style="list-style-type: none"> <li>8910DM</li> <li>LTE Cat1</li> <li>LCC</li> <li>23.9*22.9mm</li> </ul>	<b>SLM326</b> <ul style="list-style-type: none"> <li>8910DM</li> <li>LTE Cat1</li> <li>LCC+LGA</li> <li>27.6*25.4mm</li> </ul>	<b>2022Q1 SLM332</b> <ul style="list-style-type: none"> <li>Unisoc 8850</li> <li>LTE Cat1</li> <li>LCC</li> <li>15.7*17.6mm</li> </ul>
<b>SLM156</b> <ul style="list-style-type: none"> <li>MDM9205</li> <li>NB-IoT/CatM/GPRS</li> <li>LCC</li> <li>17.6*15.9*2.3mm</li> </ul>	<b>SLM130</b> <ul style="list-style-type: none"> <li>EC616/QC212</li> <li>NB-IoT</li> <li>LCC</li> <li>17.6*15.9*2.3mm</li> </ul>	<b>SLM160</b> <ul style="list-style-type: none"> <li>EC616</li> <li>NB-IoT</li> <li>LCC</li> <li>18*16mm</li> </ul>	<b>SLM190</b> <ul style="list-style-type: none"> <li>EC616</li> <li>NB-IoT</li> <li>LCC+LGA</li> <li>23.6*19.9mm</li> </ul>	<b>SLM100</b> <ul style="list-style-type: none"> <li>EC616</li> <li>NB-IoT</li> <li>LGA</li> <li>10.0*10.0mm</li> </ul>	

Before 2020

2021

2022



# Android SoC Roadmap



5G

High

Middle

Low



2\*A77 2.0Ghz +6\*A55 1.8Ghz  
8nm  
2\* HVX512  
Dual Display



1\*2.7GHz + 3\*2.4GHz  
+ 4\*1.9GHz  
6nm  
11 Tops AI  
2\*PCleDual Display  
2\*USB



2\*2.1GHz A78  
+ 4\*1.8GHz A55  
6nm  
3.5 Tops AI  
2\*PCleDual Display  
2\*USB



1\*3.2GHz + 3\*2.75GHz  
+ 4\*2.0GHz  
4nm  
~27 Tops  
5G-NR, R16  
GPS L1+L5  
WIFI 6E



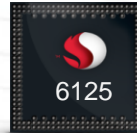
4 + 4 Kryo™ 585  
7nm  
Triple Display(5040x2160 @60Hz)  
6 x CSI-4lane  
2 USB 3.1



2\*2.4Ghz + 6\*A55  
4nm  
Sub6G+WiFi6E  
BT5.2




4\*A73 2.2Ghz +4\*A53 1.8Ghz  
14nm  
Triple Display  
Adreno512 650Mhz




4\*A73 2.0Ghz + 4\*A53 1.8Ghz  
11nm  
Adreno 610  
2 x HVX@1Ghz  
Dual Display



2\*A76 2.2Ghz +6\*A55 1.9Ghz  
Android 12/13/14  
De/En 1080p 60fps



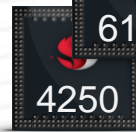
SDM450  
14nm FF  
12x14mm



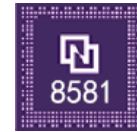
SDM625  
8953  
14nm FF  
12x14mm

8\*A53 2.0Ghz  
14nm

8\*A53 1.8Ghz  
14nm



4\*A73 2.0Ghz + 4\*A53 1.8Ghz  
11nm  
Adreno 610  
2 x HVX@1Ghz



8\*A53 1.6Ghz  
28nm  
Android 10/11



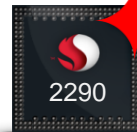
4\*A73 2.2Ghz + 4\*A53 1.8Ghz  
6nm  
Adreno 610  
Android13



4\*A53 1.3Ghz  
28nm  
Adreno308



4\*A53 1.4Ghz  
28nm  
Android 10/11



4\*A53 2.0Ghz  
11nm  
Android12

Planning

Developing

MP

2021

2022

2023

# Smart Module



5G

High

Mid

Entry



**2021 SLM900**

- SDM660
- 8-Cores 2.2Ghz
- 45.5mm\*41mm
- WIFI 2.4G/5G

**2021 SLM920**

- QCM6125
- 8-Cores 2.0Ghz
- 45.5mm\*41mm
- WIFI 2.4G/5G

**2021 SRM900**

- SM6350
- SUB6G+SA/NSA
- 8-Cores 2.0Ghz
- L1+L5 GPS
- WIFI6 ready

**2022 SRM930**

- QCM6490
- SUB6G+SA/NSA
- 8-Cores 2.7Ghz
- L1+L5 GPS
- WIFI6

**2022 SNM951**

- QCS8250
- 8-Cores 2.84Ghz
- WIFI 6
- 15 Tops AI

**2021 SLM758L**

- SDM450
- 8-Cores 1.8Ghz
- 45.5mm\*41mm
- WIFI 2.4G/5G

**2021 SLM758N**

- MSM8953
- 8-Cores 2.0Ghz
- 45.5mm\*41mm
- WIFI 2.4G/5G

**2021 SLM500L**

- SDM450
- 8-Cores 1.8Ghz
- 40.5mm\*40.5mm
- WIFI 2.4G/5G

**2021 SLM921**

- QCM6125
- 8-Cores 2.0Ghz
- 44mm\*43mm
- WIFI 2.4G/5G

**2021 SRM910**

- SM6350
- SUB6G+SA/NSA
- 8-Cores 2.0Ghz
- L1+L5 GPS
- WIFI6 ready

**2022 SRM935**

- QCM6490
- SUB6G+SA/NSA
- 8-Cores 2.7Ghz
- L1+L5 GPS
- WIFI6

**2021 SLM757**

- MSM8917
- 4-Cores 1.4Ghz
- 41mm\*41mm
- WIFI 2.4G/5G

**2021 SLM759**

- SDM450
- 8-Cores 1.8Ghz
- 44mm\*43mm
- WIFI 2.4G/5G

**2021 SLM500Q**

- QCM2150
- 4-Cores 1.3Ghz
- 40.5mm\*40.5mm
- WIFI 2.4G/5G

**2021 SLM550**

- QCM2290
- 4-Cores 2.0Ghz
- 40.5mm\*40.5mm
- WIFI 2.4G/5G

**2021 SRM900L**

- SM4350
- SUB6G+SA/NSA
- 8-Cores 2.0Ghz
- L1+L5 GPS
- WIFI6 ready

**2022 SLM550S**

- UNISOC 8581
- 8-Cores 1.6Ghz
- 40.5mm\*40.5mm
- WIFI 2.4G

**2021 SLM755L**

- MSM8909
- 4-Cores 1.1Ghz
- 40.5mm\*40.5mm
- WIFI 2.4G

**2021 SLM756**

- MSM8909
- 4-Cores 1.1Ghz
- 39mm\*44mm
- WIFI 2.4G/5G

**2021 SLM500S**

- UNISOC 8541E
- 4-Cores 1.4Ghz
- 40.5mm\*40.5mm
- WIFI 2.4G

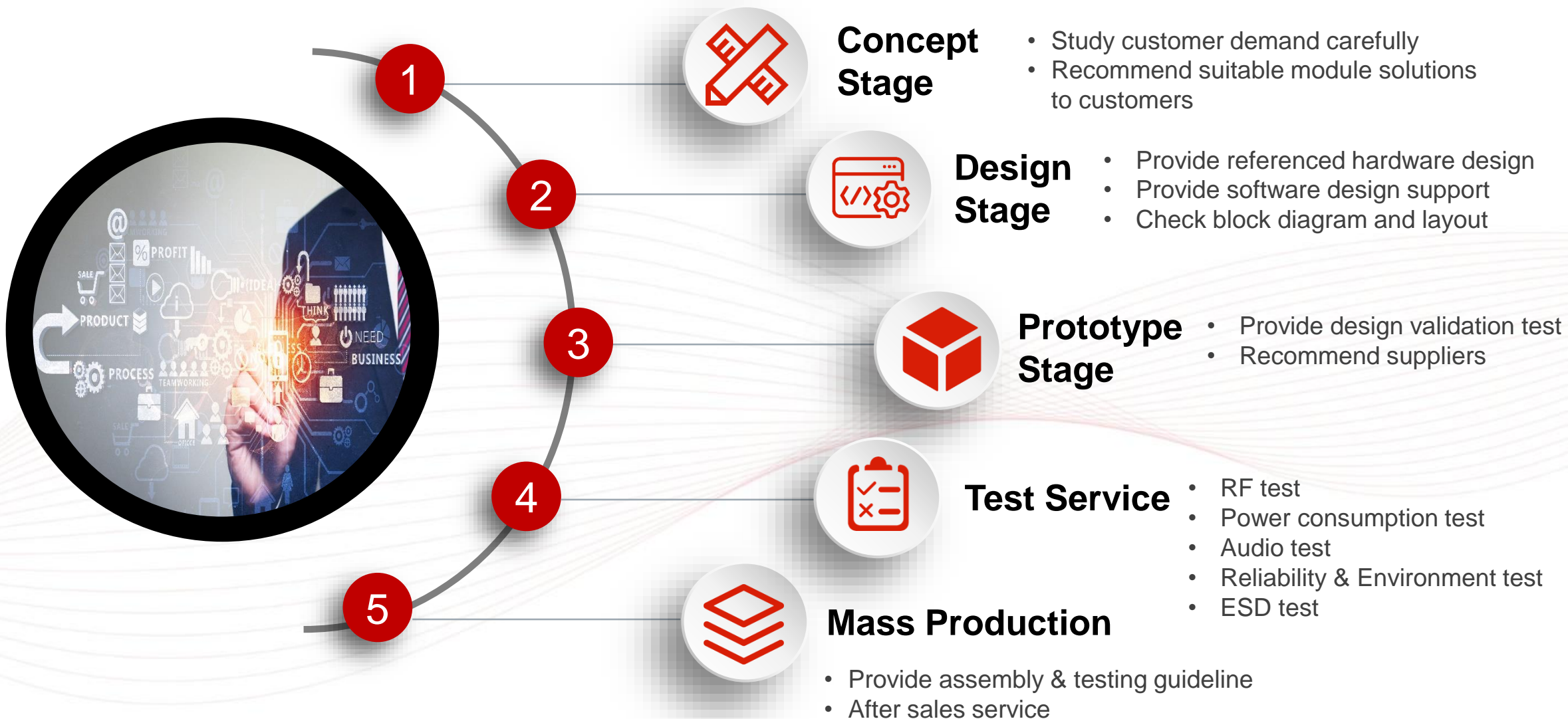


Before 2020

2021

2022

# Customized Service



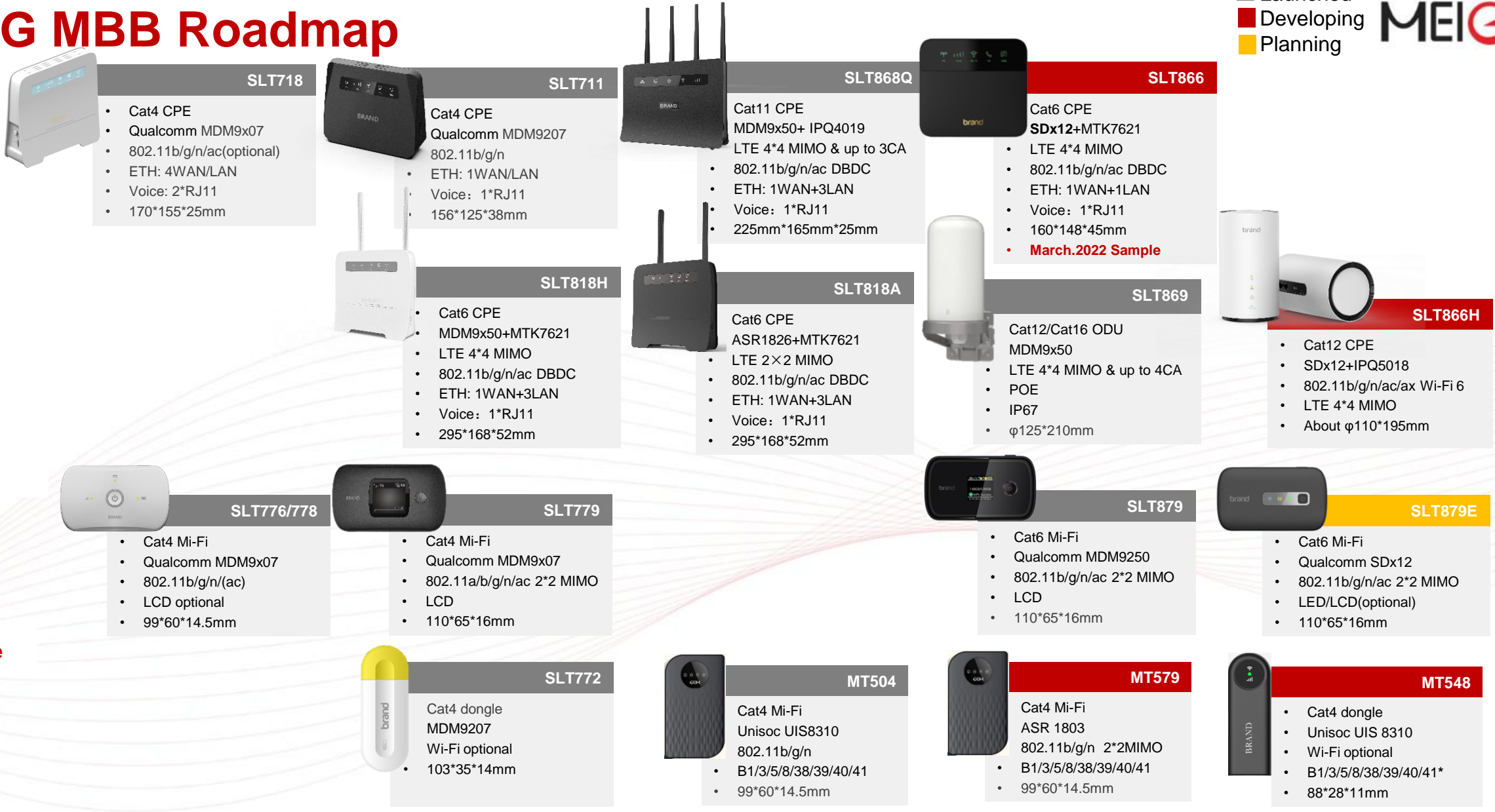


# 4G MBB Roadmap

CPE

MiFi

Dongle



Before 2020
2021
2022
2023

# 5G MBB Roadmap



- Launched
- Developing
- Planning

CPE IDU

MiFi/Dongle

CPE ODU

 <p><b>SRT838S</b></p> <ul style="list-style-type: none"> <li>5G CPE</li> <li>Qualcomm SDx55 R1</li> <li>Sub6, SA&amp;NSA, 4*4 MIMO</li> <li>802.11a/b/g/n/ac/ax WiFi6</li> <li>Low cost</li> <li>About 160*72*53mm</li> </ul>	 <p><b>SRT858</b></p> <ul style="list-style-type: none"> <li>5G CPE</li> <li>SDX62</li> <li>Sub6, SA&amp;NSA, 4*4 MIMO</li> <li>802.11b/g/n/ac/ax, Wi-Fi 6</li> <li>ETH: 1G*2</li> <li>About 217.6*φ112mm</li> </ul>	 <p><b>SRT838iPro</b></p> <ul style="list-style-type: none"> <li>5G CPE</li> <li>Qualcomm SDx62 R16</li> <li>Sub6, SA&amp;NSA, 4*4 MIMO</li> <li>802.11a/b/g/n/ac/ax WiFi6</li> <li>Low cost</li> <li>About 160*72*53mm</li> </ul>	 <p><b>SRT838C</b></p> <ul style="list-style-type: none"> <li>5G CPE</li> <li>Unisoc V510</li> <li>Sub6, SA&amp;NSA, 4*4 MIMO</li> <li>802.11a/b/g/n/ac/ax</li> <li>About 160*72*53mm</li> <li>2023 Q2</li> </ul>	 <p><b>SRT858H</b></p> <ul style="list-style-type: none"> <li>5G CPE</li> <li>SDx62-1-AA-IPQ5018</li> <li>Sub6, SA&amp;NSA, 4*4 MIMO</li> <li>802.11a/b/g/n/ac/ax</li> <li>About 217.6*φ112mm</li> <li>2023 Q2</li> </ul>	 <p><b>SRT858M</b></p> <ul style="list-style-type: none"> <li>5G CPE</li> <li>Qualcomm SDx72-1</li> <li>DL 4x4 MIMO</li> <li>802.11a/b/g/n/ac/ax/ae AX5800</li> <li>About 217.6*φ112mm</li> <li>2023 Q4</li> </ul>	 <p><b>SRT835</b></p> <ul style="list-style-type: none"> <li>5G CPE</li> <li>Qualcomm SDx35 R17</li> <li>DL 2x2 MIMO</li> <li>36802.11a/b/g/n/ac</li> <li>About 120*74*18mm</li> <li>2023 Q4</li> </ul>
 <p><b>SRT873H/HS</b></p> <ul style="list-style-type: none"> <li>5G Mi-Fi</li> <li>Qualcomm SDx55</li> <li>802.11b/g/n/ac/ax 2*2 MIMO</li> <li>LCD</li> <li>5000mA Battery</li> <li>130*70*19.5mm</li> </ul>	 <p><b>SRT875H</b></p> <ul style="list-style-type: none"> <li>5G Mi-Fi</li> <li>Qualcomm SDx62 R16</li> <li>NR(DL/UL)3.16Gbps/550Mbps</li> <li>802.11b/g/n/ac/ax 2*2 MIMO</li> <li>LCD</li> <li>About 133.5*71*17mm</li> </ul>	 <p><b>SRT875A</b></p> <ul style="list-style-type: none"> <li>5G Mi-Fi</li> <li>Qualcomm SDx65 R16</li> <li>NR(DL/UL)4.8Gbps/900Mbps</li> <li>802.11b/g/n/ac/ax 2*2 MIMO AX3600</li> <li>LCD</li> <li>About 133.5*71*17mm</li> </ul>	 <p><b>SRT876(EU)</b></p> <ul style="list-style-type: none"> <li>5G Mi-Fi</li> <li>V510 + UWE5623DU</li> <li>802.11 a/b/g/n/ac 2*2 MIMO DBSC</li> <li>LED</li> <li>3600mA Battery</li> <li>130*70*19.5mm</li> </ul>	 <p><b>SRB876CB</b></p> <ul style="list-style-type: none"> <li>5G Mi-Fi 公版</li> <li>V510 + UWE5623DU</li> <li>802.11 a/b/g/n/ac 2*2 MIMO DBSC</li> <li>LED</li> </ul>	 <p><b>SRT878H</b></p> <ul style="list-style-type: none"> <li>5G Mi-Fi</li> <li>Qualcomm SDx72</li> <li>5G NR Sub-6GHz</li> <li>802.11b/g/n/ac/ax 2*2 MIMO</li> <li>5000mA Battery</li> <li>About 140*74*18mm</li> <li>Q1.2024</li> </ul>	
	 <p><b>SRT853A</b></p> <ul style="list-style-type: none"> <li>5G ODU</li> <li>Qualcomm SDx62 R16</li> <li>Sub6 SA&amp;NSA</li> <li>2.5G Ethernet POE</li> <li>IP65</li> <li>186*111*35mm</li> </ul>	 <p><b>SRT853M</b></p> <ul style="list-style-type: none"> <li>Qualcomm SDx62 R16</li> <li>Sub-6&amp;mmWave</li> <li>DL 4.3Gbps/2.3Gbps</li> <li>186*111*35mm</li> <li>2.5G Ethernet</li> <li>POE, IP65</li> <li>QTM547*1</li> <li>sup Parabolic Antenna</li> </ul>	 <p><b>SRT853L</b></p> <ul style="list-style-type: none"> <li>SDx65 R16</li> <li>Sub6 &amp; mmWave</li> <li>DL 10Gbps/3.38Gbps</li> <li>10G Ethernet POE</li> <li>IP65</li> <li>QTM547*2</li> <li>186*111*35mm</li> <li>sup Parabolic Antenna</li> </ul>	 <p><b>SRT853P</b></p> <ul style="list-style-type: none"> <li>Parabolic Antenna</li> <li>Φ 198mm</li> <li>Fre:24.25-29.5GHz</li> <li>Beam Width: 2~2.5°</li> <li>Polarization: Dual-polarized</li> <li>Gain: 30dBi</li> </ul>		

# ODM Products Portfolios

5G

Middle

Low


**5G VideoCamera**

- 5G SM6350
- Android 11
- LCD : 2.4 inch
- 64GB+4GB




**5G PDA**

- 5G SM6350
- Android 11
- LCD : 6 inch
- 64GB+4GB



**5G PDA**

- 5G QCM4490
- Android 13
- LCD: 6.0 inch
- 64GB+4GB




**5G PDA**

- 5G QCM6490
- Android 13
- LCD: 6.0 inch
- 128GB+8GB




**4G PDA**

- SM6115
- Android 11
- LCD : 5.5 inch
- 64GB+4GB




**4G PAD**

- Oct-Cores
- Android 11
- 8' 1440x720
- 32GB+3GB



**4G 10' PAD**

- SDM660
- Android 12
- 10' 2160x1080
- 64GB+4GB



**4G 7' PAD**

- SDM660
- Android 12
- 7' 2160x1080
- 64GB+4GB



**MPOS**

- UIS8310
- CAT1
- LCD: 2.5 inch
- 4Gb+1Gb




**4G POS**

- CM2150
- Android 9
- LCD: 4 inch
- 8GB+1GB



**4G POS**

- UIS8581
- Android 11
- LCD: 6.0 inch
- 16GB+2GB



**4G POS**

- QCM2290
- Android 11 Go
- 5" HD
- 1GB+8GB



20~21

2022

2023





# Mobile Computer Solution



- 4G PAD**
- SDM660
  - Android 11
  - 10' 2160x1080
  - 64GB+4GB
  - WIFI 2X2

- 4G PAD**
- SM6115
  - Android 12
  - 10' 2160x1080
  - 64GB+6GB
  - WIFI ax-ready

- 5G-PAD**
- 5G SM4350Pro
  - Android 12
  - LCD: 10 inch
  - 128GB+6GB
  - WIFI ax-ready

- 5G-PAD**
- 5G QCM6490
  - Android 13-16
  - LCD: 10 inch
  - 128GB+8GB
  - WIFI6/6E



- 4G PDA**
- SM6115
  - Android 12
  - 5.5' 1440x720
  - 64GB+4GB Discrete
  - WIFI ax-ready

- 4G PDA**
- QCM4290
  - Android 12-14
  - 5.5' 1440x720
  - 64GB+4GB
  - WIFI6

- 5G PDA**
- 5G SM6350
  - Android 11
  - LCD: 6.0 inch FHD
  - 64GB+4GB
  - WIFI ax-ready

- 5G PDA**
- 5G QCM6490
  - Android 12-15
  - LCD: 6.0 inch FHD
  - 128GB+6GB
  - WIFI6/6E

- 5G PDA**
- 5G QCM4490
  - Android 13-17
  - LCD: 6.0 inch HD+
  - 64GB+4GB
  - WIFI6/6E

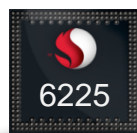
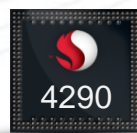
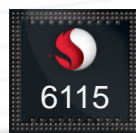


- 4G Keyboard**
- SDM660
  - Android 12
  - 4' FHD
  - 64GB+4GB
  - WIFI 2X2

- 4G Keyboard**
- SM6115
  - Android 12-14
  - 3.5' HD
  - 64GB+4GB
  - WIFI ax-ready

- 4G Keyboard**
- QCM4290
  - Android 12-14
  - 4.0' HD
  - 64GB+6GB
  - WIFI6

- 5G Keyboard**
- QCS6490
  - Android 14/15
  - 4.3' WVGA
  - 64GB+4GB
  - WIFI ax



# Smart POS Solution



# ECR Solution



Dual Display



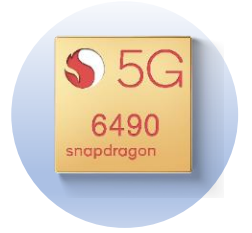
Face Recognition



Advanced Performance



Flagship



PCBA/Module Solution

